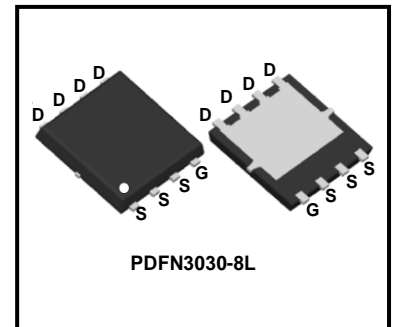


100V N-Channel Enhancement Mode Power MOSFET

Description

WMQ099N10LG2 uses Wayon's 2nd generation power trench MOSFET technology that has been especially tailored to minimize the on-state resistance and yet maintain superior switching performance. This device is well suited for high efficiency fast switching applications

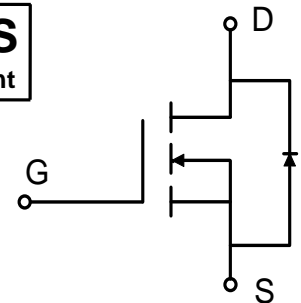


Features

- $V_{DS} = 100V$, $I_D = 47A$
 $R_{DS(on)} < 11m\Omega @ V_{GS} = 10V$
 $R_{DS(on)} < 14m\Omega @ V_{GS} = 4.5V$
- Low Gate Charge
- High Speed Power Switching
- 100% EAS Guaranteed

Applications

- High Efficiency Power Supply
- Secondary Synchronous Rectifier



Absolute Maximum Ratings ($T_A = 25^\circ C$, unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain-Source voltage	V_{DS}	100	V
Gate-Source voltage	V_{GS}	± 20	V
Continuous Drain Current	I_D	$T_C = 25^\circ C$	47
		$T_C = 100^\circ C$	30
Pulsed Drain Current ¹	I_{DM}	188	A
Single Pulse Avalanche Energy ²	EAS	39.2	mJ
Total Power Dissipation	P_D	41.6	W
Operating Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^\circ C$

Thermal Characteristics

Parameter	Symbol	Value	Unit
Thermal Resistance from Junction-to-Ambient ³	$R_{\theta JA}$	50.5	$^\circ C/W$
Thermal Resistance from Junction-to-Case	$R_{\theta JC}$	3	$^\circ C/W$

Electrical Characteristics (T_A = 25°C, unless otherwise noted)

Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static Characteristics						
Drain-Source Breakdown Voltage	V_{(BR)DSS}	V _{GS} = 0V, I _D = 250μA	100	-	-	V
Gate-body Leakage current	I_{GSS}	V _{DS} = 0V, V _{GS} = ±20V	-	-	±100	nA
Zero Gate Voltage Drain Current	T _J =25°C	V _{DS} = 100V, V _{GS} = 0V	-	-	1	μA
	T _J =100°C		-	-	100	
Gate-Threshold Voltage	V_{GS(th)}	V _{DS} = V _{GS} , I _D = 250μA	1.3	1.85	2.5	V
Drain-Source on-Resistance ⁴	R_{DS(on)}	V _{GS} = 10V, I _D = 20A	-	9	11	mΩ
		V _{GS} = 4.5V, I _D = 20A	-	12	14	
Forward Transconductance ⁴	g_{fs}	V _{DS} = 5V, I _D = 10A	-	80	-	S
Dynamic Characteristics⁵						
Input Capacitance	C_{iss}	V _{DS} = 50V, V _{GS} = 0V, f = 1MHz	-	1620	-	pF
Output Capacitance	C_{oss}		-	300	-	
Reverse Transfer Capacitance	C_{rss}		-	8	-	
Gate Resistance	R_g	f = 1MHz	-	1	-	Ω
Switching Characteristics⁵						
Total Gate Charge	Q_g	V _{GS} = 10V, V _{DS} = 50V, I _D = 20A	-	23	-	nC
Gate-Source Charge	Q_{gs}		-	3.8	-	
Gate-Drain Charge	Q_{gd}		-	6.3	-	
Turn-on Delay Time	t_{d(on)}	V _{GS} = 10V, V _{DD} = 50V, R _G = 10Ω, I _D = 20A	-	5.9	-	ns
Rise Time	t_r		-	3.9	-	
Turn-off Delay Time	t_{d(off)}		-	17	-	
Fall Time	t_f		-	2.9	-	
Body Diode Reverse Recovery Time	t_{rr}	I _F = 20A, dI/dt = 500A/μs	-	42	-	ns
Body Diode Reverse Recovery Charge	Q_{rr}		-	155	-	nC
Drain-Source Body Diode Characteristics						
Diode Forward Voltage ⁴	V_{SD}	I _S = 20A, V _{GS} = 0V	-	-	1.2	V
Continuous Source Current	T _C =25°C	I_s	-	-	47	A

Notes:

1. Repetitive rating, pulse width limited by junction temperature T_{J(MAX)} = 150°C.
2. The EAS data shows Max. rating. The test condition is V_{DD} = 25V, V_{GS} = 10V, L = 0.1mH, I_{AS} = 28A.
3. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, The value in any given application depends on the user's specific board design.
4. The data tested by pulsed, pulse width ≤ 300us, duty cycle ≤ 2%.
5. This value is guaranteed by design hence it is not included in the production test.

Typical Characteristics

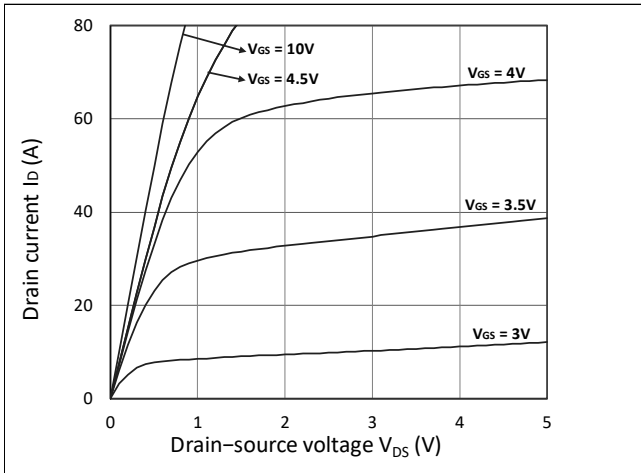


Figure 1. Output Characteristics

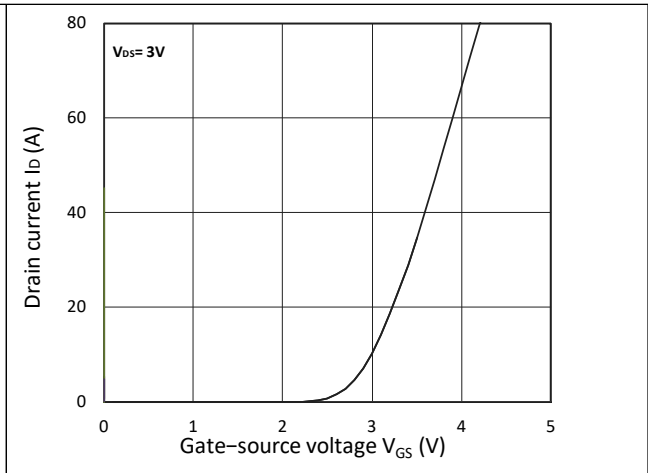


Figure 2. Transfer Characteristics

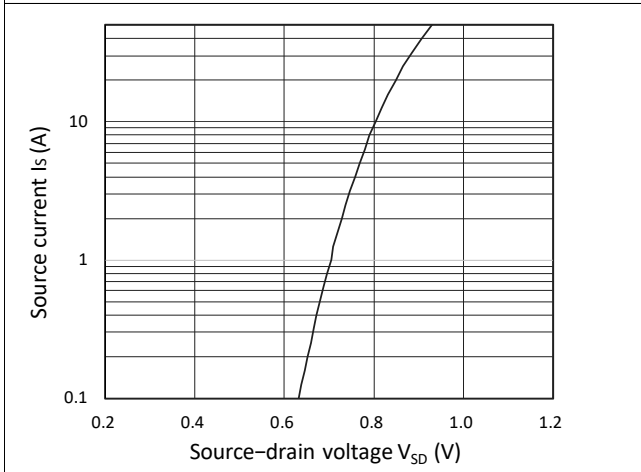


Figure 3. Forward Characteristics of Reverse

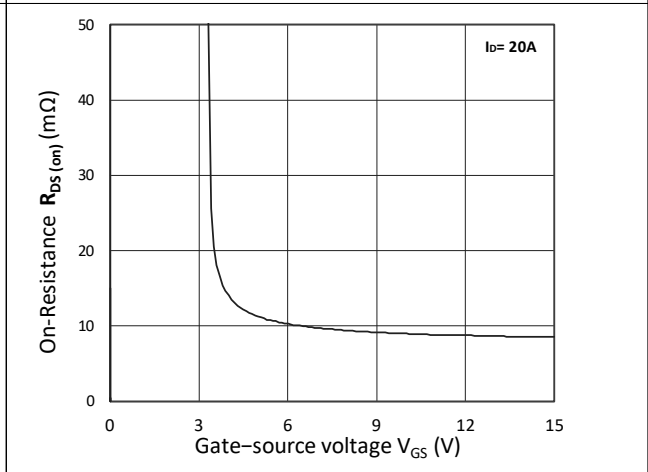


Figure 4. $R_{DS(ON)}$ vs. V_{GS}

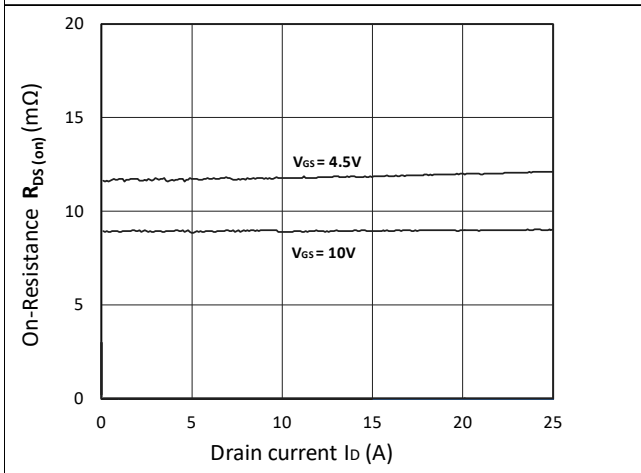


Figure 5. $R_{DS(ON)}$ vs. I_D

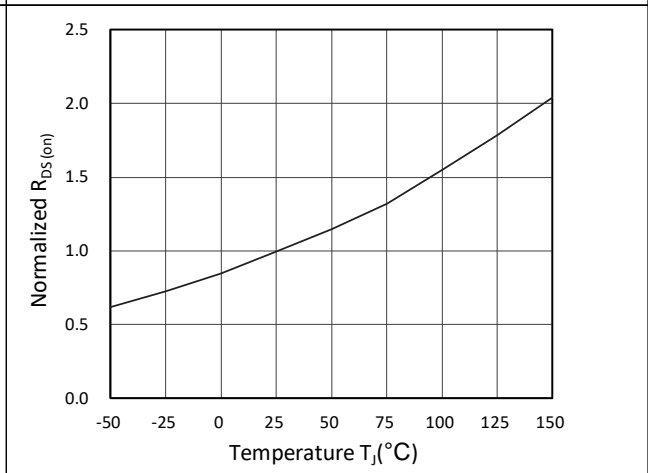


Figure 6. Normalized $R_{DS(ON)}$ vs. Temperature

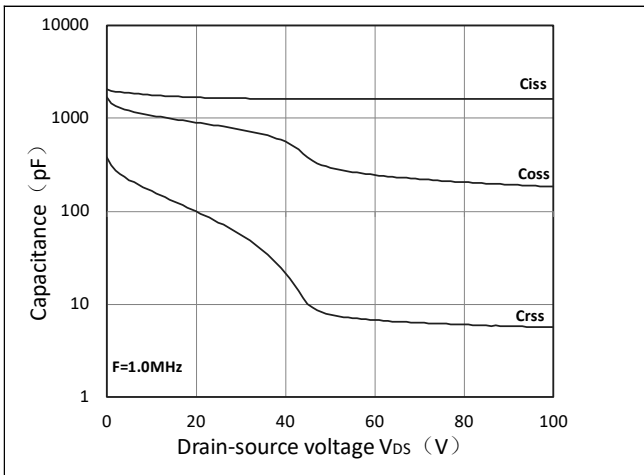


Figure 7. Capacitance Characteristics

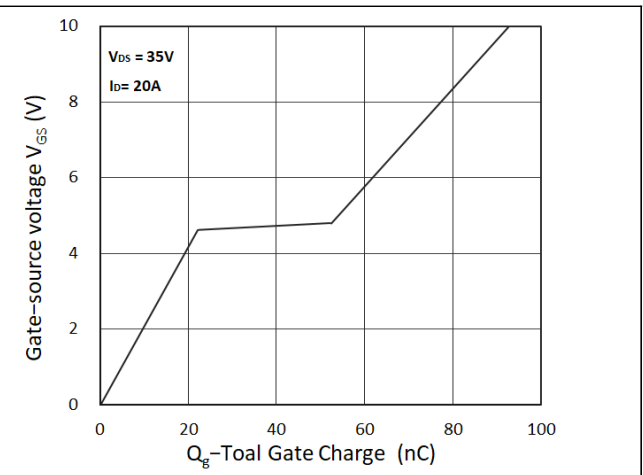


Figure 8. Gate Charge Characteristics

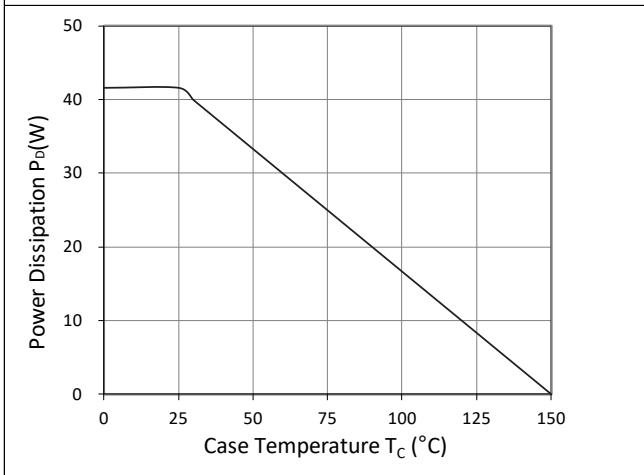


Figure 9. Power Dissipation

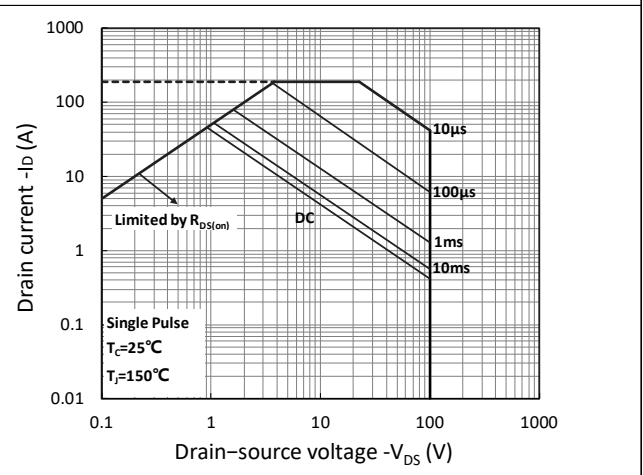


Figure 10. Safe Operating Area

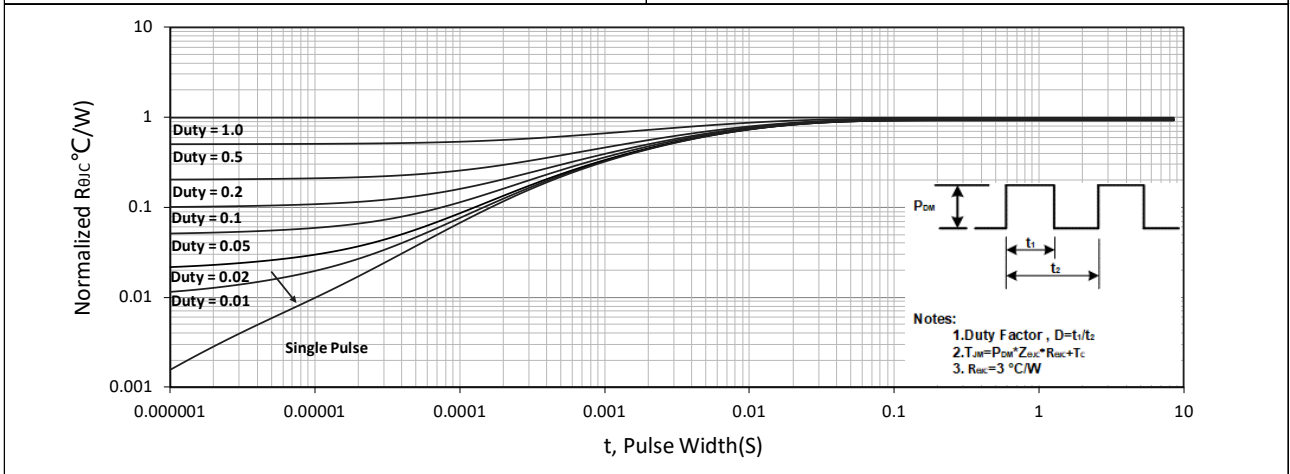


Figure 11. Normalized Maximum Transient Thermal Impedance

Test Circuit

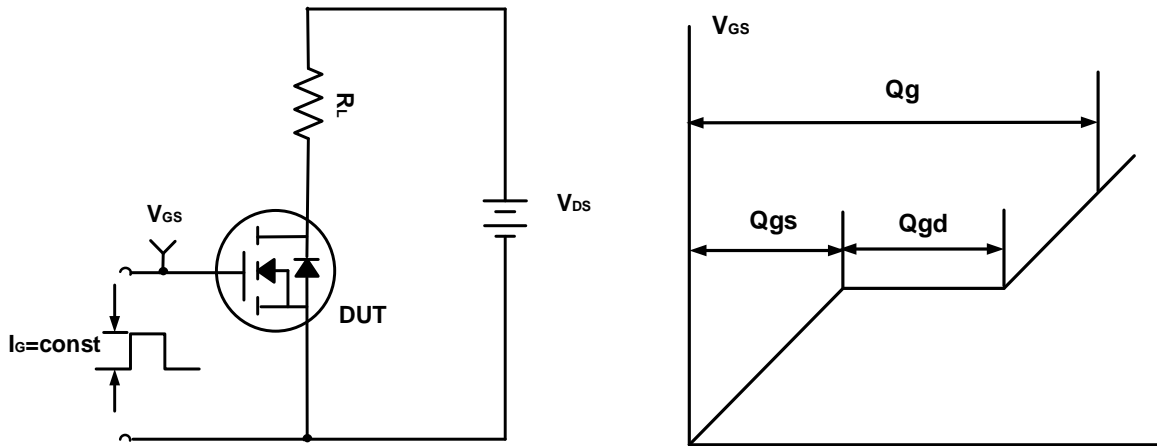


Figure A. Gate Charge Test Circuit & Waveforms

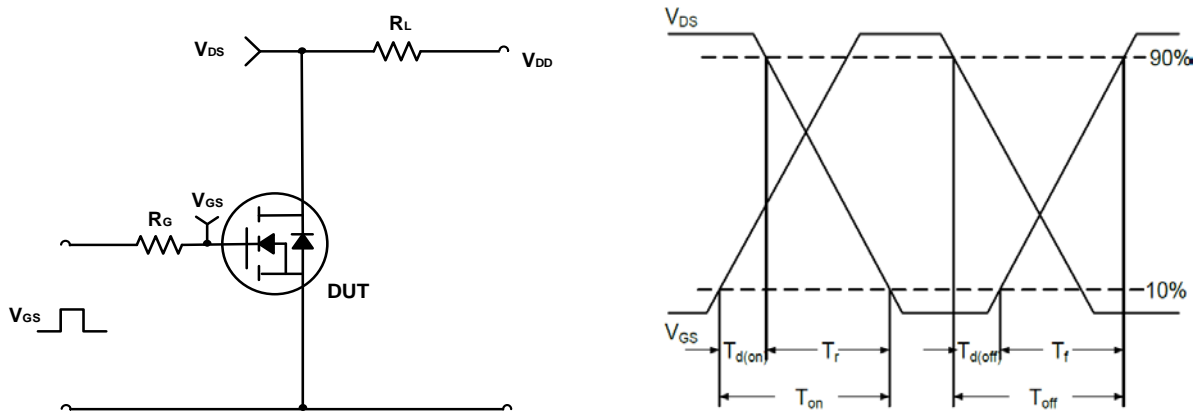


Figure B. Switching Test Circuit & Waveforms

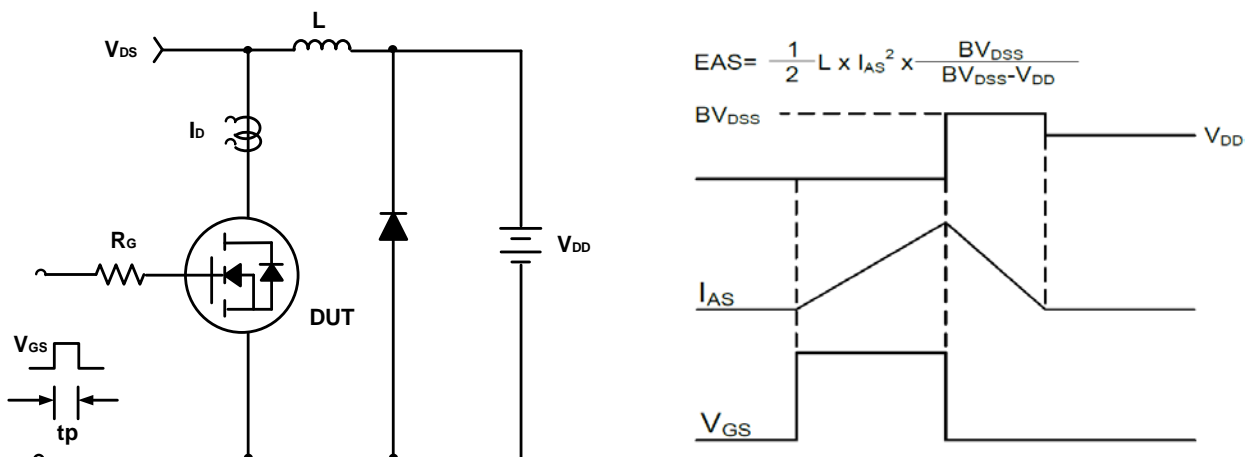
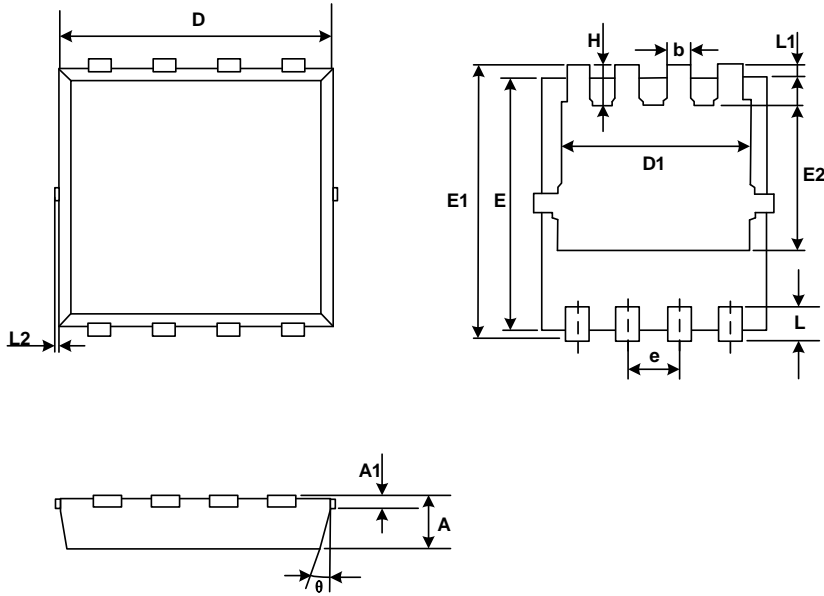


Figure C. Unclamped Inductive Switching Circuit & Waveforms

Mechanical Dimensions for PDFN3030-8L

COMMON DIMENSIONS

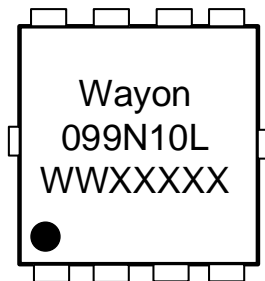


SYMBOL	MM	
	MIN	MAX
A	0.65	0.90
A1	0.10	0.25
D	2.90	3.25
D1	2.25	2.69
E	2.90	3.20
E1	3.00	3.60
E2	1.35	2.20
b	0.20	0.40
e	0.65BSC	
L	0.15	0.50
L1	0.13BSC	
L2	0.00	0.20
H	0.15	0.65
θ	0°	14°

Ordering Information

Part	Package	Marking	Packing method
WMQ099N10LG2	PDFN3030-8L	099N10L	Tape and Reel

Marking Information



099N10L = Device code
 WWXXXXX= Date code


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WAYON website: <http://www.way-on.com>

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